April, 1998



(SCM7592-XC)



Technical Specification for

Optical Transceiver Module

SCM7592-XC

L	Intermediate Reach	Long Reach	other	
	Single 5.0 V	Single 3.3 V	other	
[1.3 µm	1.55 μm	other	
[Transmitter	Receiver	Transceiver	
		(2R / 3R)	(ZR / 🔲 3R)	
			,	
	SUMITOMO E	ELECTRIC IND	USTRIES, LTD.	
			,	
	Electric reserves the right t	o make changes in the spec	cification described hereinafter without	prior
notice. — — — — –				
other persons or		riate use of the product. The symb	cture symbols to prevent possible injury to opera ols and definitions are as shown below. Be sure	
∧ Warr			d to human death or serious injury.	
⚠ Cau	tion Wrong operation withou	t following this instruction may lead	I to human injury or property damage.	
Example of pictu	ire symbols indicates proh	bition of actions. Action details are	explained nearby.	
	indicates comp	oulsory actions or instructions. Acti	on details are explained near by.	

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1. General

SCM7592-XC is a compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

* Data Rate 622.08 Mbps, NRZ

* Duty Cycle 50%

* Power Supply Voltage Single +3.3V * Electrical Interface PECL(Data)

* Fiber Coupled Power -8 ~ -15dBm (Typ. -11dBm) for SMF

* Sensitivity -8 ~ -28dBm

* Connector Interface SC Duplex Connector

The features of SCM7592-XC are listed below.

* Features Low Power Supply Voltage / Low Power Consumption

Plastic Molded Package Multi-sourced Footprint

Transmitter..... Uncooled Laser with Automatic Power Control IC

Optical Output Shut-down (Disable)

Laser Bias Current Monitor / Optical Output Power Monitor

Class 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)

Receiver...... Wide Dynamic Range

ITU-T G.957 / G.958 and Bellcore TA-NWT-000253 Compliant Signal Detect (FLAG) Function / Optical Input Power Monitor

2. Block Diagram

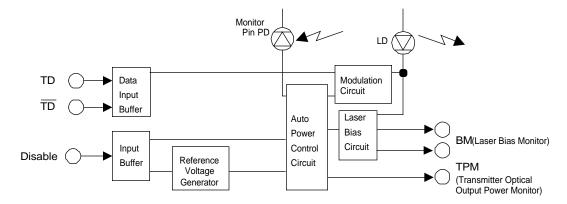


Figure 1-1. Block Diagram (Transmitter)

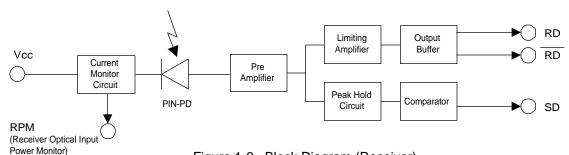


Figure 1-2 Block Diagram (Receiver)

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3. Package Dimension

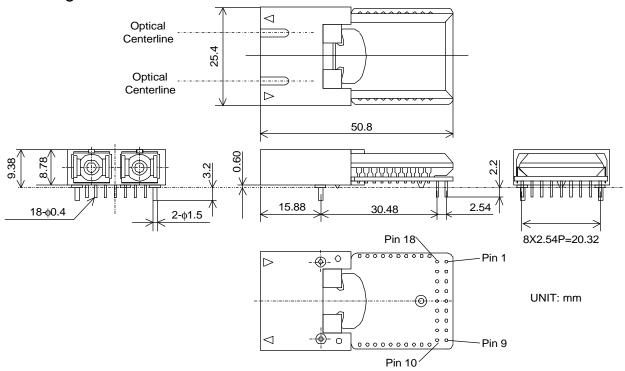


Figure 2. Package Dimension

∆ Caution

Do not disassemble this product. Otherwise, failure, electrical shock overheating or fire may occur.

Handle the lead pin carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

4. Pin Assignment

No.	Symbol	Function
1	NC	Non Connection (Internally)
2	NC	Non Connection (Internally)
3	NC	Non Connection (Internally)
4	NC	Non Connection (Internally)
5	BM(-)	Monitoring pin for LD Bias Monitor
6	BM(+)	Monitoring pin for LD Bias Monitor
7	Disable	LD Disable Input
8	RPM	Receiver Optical Input Power Monitor
9	TPM	Transmitter Optical Output Power Monitor
10	Veetx	Power Supply (-) for Transmitter : Connected to GND
11	TD	Transmitter Differential Data (Positive)
12	TD	Transmitter Differential Data (Negative)
13	Vcctx	Power Supply (+) for Transmitter : Connected to +3.3V
14	Vccrx	Power Supply (+) for Receiver : Connected to +3.3V
15	FLAG(SD)	FLAG (Signal Detect)
16	RD	Received Differential Data (Negative)
17	RD	Received Differential Data (Positive)
18	Veerx	Power Supply (-) for Receiver : Connected to GND or additional functions in the future

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5. Absolute Maximum Ratings

Parameter	Symbol	min.	Max	Unit	Note
Storage Case Temperature	Ts	-40	85	°C	1
Operating Case Teperature	Tc	-5	70	°C	1
Supply Voltage	Vcc-Vee	0.0	4.0	V	2
Input Voltage	Vi	Vee	Vcc+0.5	V	3
Lead Soldering (Temperature)			260	°C	4
(Time)			10	sec.	

Note 1. No condensation allowed. 2. Vcc>Vee, Vcc=+3.3V, Vee=GND

3. TD, TD, Disable 4. Measured on lead pin at 2mm (0.079in.) off the package bottom

▲ Warning

<u>n</u>

Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.



Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

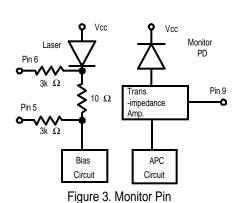
6. Electrical Interface

(Unless otherwise specified, Vcc-Vee = 3.14 to 3.47 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter		Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	3.14	3.30	3.47	V	
Supply Current		ldtx		70	140	mA	1, 2, 3
Input Voltage	High	Vih	Vcc-1.17		Vcc-0.73	V	4, 5
TD, TD	Low	Vil	Vcc-1.95		Vcc-1.45		
Input Current	High	lih	-10		150	μΑ	4, 5
TD, TD	Low	lil	-10		10		
Signal Input Rise / Fall Time					0.5	nsec.	6
Disable Input Voltage		Vdi	Vee+2.0		Vcc	V	7
Disable Input Current		ldi	-10	140	200	μΑ	
Enable Input Voltage		Vei	Vee		Vee-0.8	V	
LD Bias Monitor Voltage		Vbm	0.01	0.05	0.50	V	5, 8
	Low level				0.2	V	9
Optical Output Monitor	Normal	Vtpm		0.6			
	High level	1	1.1				

Note 1. Input bias current is not included. 2. 50% duty cycle data 3. 622.08Mbps 4. Vcc-Vee=3.3V 5. Tc=25°C 6. 20~80% 7. The transmitter is enabled as default state and requires an external voltage only to disable. (Refer to Section 8. Relation between Disable Input Voltage and Optical Output Power) 8. The Laser Bias Monitor Current is calculated a ratio of the corresponding voltages to their current-sensing resistor, 10Ω (See Figure 3). Upon Measuring or utilzing these values, please use a device whose Impedance is high enough (>1M Ω) compared with those resistors. 9. The relationship between the Output Power Change and the Tranmitter Optical Power Monitor Voltage is shown in Figure 4.



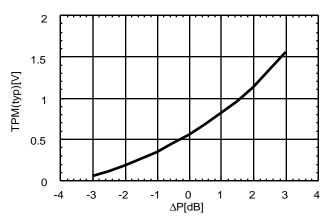


Figure 4. Output Power Change versus the Optical Output Monitor Voltage (typ.)

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6-2. Receiver side

Paramet	er	Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	3.14	3.30	3.47	V	
Supply Current		ldrx		95	125	mA	1
Data and SD(FLAG)	High	Voh	Vcc-1.10		Vcc-0.86	V	2
Output Voltage	Low	Vol	Vcc-1.86		Vcc-1.50		
Data Rise / Fall Time		Trd / Tfd			1000	psec.	3
SD (FLAG) Assert Time		Ta			100	μsec	4
SD(FLAG) Deassert Time	е	Td			350	μsec	
Optical Input Power Mon	itor @-20dBm	Vrpm		2.5		V	5
	@-28dBm			0.4			

Note

- 1. Output current is not included. 622.08Mbps, PRBS2^23-1.
- 2. Vcc=+3.3V, Tc=25°C, Output load resistance RI=50 Ω to Vcc-2V for RD, $\overline{\text{RD}}$ and FLAG.
- 3. 20~80%, Input capacitance and stray capacitance of measuring devices should be less tham 2pF.
- 4. 622.08Mbps, PRBS 2^23-1, NRZ
- 5. The relationship between the Optical Input Power and the Optical Input Monitor Voltage is shown in Figure 5.

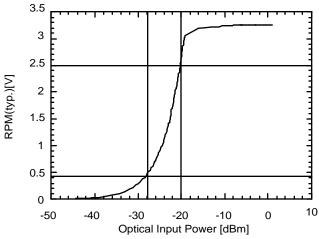


Figure 5. Iutput Power versus the Optical Input Monitor Voltage (typ.)

7. Optical Interface

(Unless otherwise specified, Vcc-Vee = 3.14 to 3.47 V and all operating temperature shall apply.)

7-1. Transmitter side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Average Output Power	Po	-15.0		-8.0	dBm	1
Extinction Ratio	Er	8.2			dBm	1
Center Wavelength	λς	1274		1356	nm	
Spectral Width (RMS)	$\Delta\lambda$			2.5	nm	
Eye Mask for Optical Output	Refer to Figure 6					

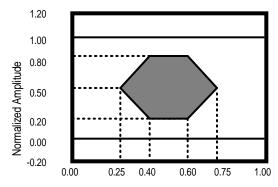


Figure 6 Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

Relation between Input Signal and Ontical Output Signal

and Optical Output Oignal						
Input	Signal	Optical Output Signal				
TD	TD					
High	Low	ON (High)				
Low	High	OFF (Low)				
High	High	Undefined				
Low	Low	Undefined				

Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

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7-2. Receiver side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Center Wavelength	-	1261		1580	nm	
Minimum Sensitivity	Pmin			-28.0	dBm	1, 2
Overload	Pmax	-8.0			dBm	1, 2
Flag Assert Level	Pa		-33		dBm	2
Flag Deassert Level	Pd		-35		dBm	

Note 1. BER=10^-10

8. Relation between Disable Input Voltage and Optical Output Power

Disable Input Voltage	Optical Output Power
"L"(Vee ~ Vee+0.8V)	Enabled
"H"(Vee+2.0V ~ Vcc)	Disabled (<-45dBm)

9. Reliability Test (Under qualification)

		sue 2, December 19					0=: -	
Heading	ding Test Reference Cond		Condition	Samplin			SEI Plan	
				LTPD	SS	С	SS	F/C
Mechanical	Mechanical	MIL-STD-883	Condition B					
Integrity	Shock	Method 2002	5 times/axis					
			500G, 1.0 ms	20%	11	0		
			1,500G, 0.5ms	20%	11	0	11	TBD
	Vibration	MIL-STD-883	Condition A	20%	11	0	11	TBD
		Method 2007	20 G					
			20-2,000 Hz					
			4 min/cycle; 4 cycles/axis					
	Thermal Shock	MIL-STD-883	ΔT=100°C	20%	11	0	11	TBD
		Method 1011						
	Solderability	MIL-STD-883	(steam aging not required)	20%	11	0	11	0
		Method 2003						
	Fiber Pull		1 Kg; 3 times;5sec.	20%	11	0		
			2 Kg; 3 times; 5sec.	20%	11	0		
Endurance	Accel. Aging	(R)-453	+85C; rated power					
	(High Temp.)	Section 5.18	>5,000hrs.		25		25	TBD
			>10,000hrs.		10			
	High Temp.		max. storage T (T=85°C)	20%	11	0		
	Storage		>2,000					
	Low Temp.		min. storage T (T=-40°C)	20%	11	0	11	TBD
	Storage		>2,000					
	Temperature	Section 5.20	- 40°C to +85°C					
	Cycling		400 times pass/fail	20%	11	0		
			500 times for info.		11			
			500 times pass/fail	20%	11	0	11	TBD
			1000 times for info.		11		11	TBD
	Damp Heat	MIL-STD-202 M103	40°C , 95%, 56days	20%	11	0	11	TBD
	(if using epoxy)	or IEC 68-2-3	or 85°C /85%RH 2,000hrs.	20%	11	0		
	Cyclic Moisture	Section 5.23		20%	11	0	11	TBD
	Resistance							
Special	Internal	MIL-STD-883	< 5,000 ppm	20%	11	0	11	TBD
Tests	Moisture	Method 1018	water vapor					
	Flammability	TR357:Sec. 4.4.2.5						ОК
	ESD Threshold	Section 5.22			6		6	TBD

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^{2.} Measured at the bit rate of 622.08Mbps, PRBS 2^23-1, NRZ

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10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR 1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 825-1.

11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.



Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.

Do not put this product or components of this product into your mouth. This product contaions material harmful to health.



Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

12. Ordering Information

Ordering Number	Connector type
SCM7592-XC	SC Duplex Connector

13. For More Information

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http://www.sei.co.jp/Electro-optic/eopd_home_e.html